RV1S9260A

HIGH CMTI, 15 Mbps CMOS OUTPUT,
LOW FORWARD-CURRENT (I_F) 3.3 V/ 5 V OPERATION,
5-PIN SSOP WITH 8.2 mm CREEPAGE DISTANCE (LSSO5) PHOTOCOUPLER

R08DS0188EJ0200
Rev.2.00
Jul. 31, 2025

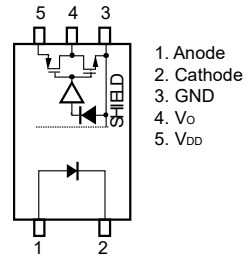
DESCRIPTION

The RV1S9260A is a photocoupler featuring high-speed switching up to 15 Mbps with active low output logic which consists of an AlGaAs LED on the input side and an integrated circuit with a photodiode on the output. This product enables to low current operation on 3.3 V/5 V power supply with high noise-tolerant CMTI:50 kV/us min. and high temperature operation up to T_A = 125 °C in logic interface circuit.
This package is very small and thin with long creepage distance (8.2 mm).
This small product is suitable for various interface circuits which require surface mounting and high-density mounting.

FEATURES

- Small and long creepage (8.2 mm MIN, LSSO5)
- High speed switching (15 Mbps)
- Operating ambient temperature (125 °C MAX.)
- High common mode transient immunity ($|CM_H|$, $|CM_L|$ = 50 kV/μs MIN.)
- High isolation voltage (BV = 5 000 Vr.m.s.)
- Low input drive current (I_{FHL} = 2.6 mA MAX.)
- Low voltage power supply operation (V_{DD} = 2.7 V ~ 5.5 V)
- Low pulse width distortion (PWD = 20 ns MAX.)
- Embossed tape product : RV1S9260ACCSP-10Yx#KC0: 3500 pcs/reel
- Pb-free product
- Safety standard
  - UL : UL1577, Double protection
  - CSA : CAN/CSA-C22.2 No.62368-1, Reinforced insulation
  - VDE : DIN EN IEC 60747-5-5 (Option)

PIN CONNECTION
(Top View)



TRUTH TABLE

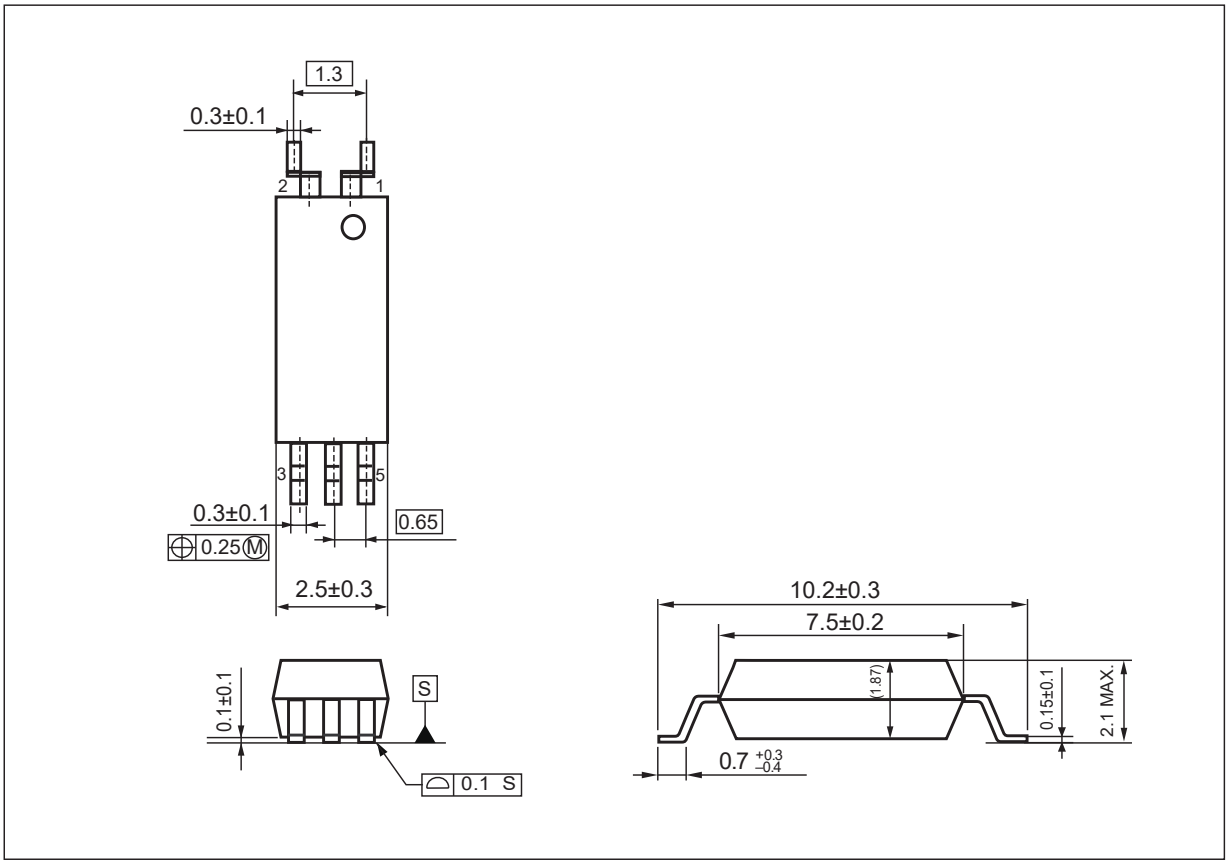
LED	OUTPUT
ON	L
OFF	H

APPLICATIONS

- Robot controller
- Industrial inverter
- AC Servo
- FA Network
- Measurement equipment

Start of mass production
Nov.2019

PACKAGE DIMENSIONS (UNIT: mm)

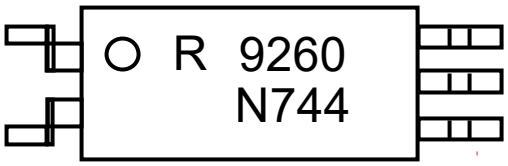


Weight : 0.075 g (TYP.)

PHOTOCOUPLER CONSTRUCTION

Parameter	MIN.
Air Distance	8.2 mm
Creepage Distance	8.2 mm
Isolation Distance	0.15 mm

MARKING EXAMPLE



R		An initial of “Renesas”	
9260		Product Part Number ＊	
○		No.1 pin Mark	
N744	N	Rank Code	
	744	Assembly Lot	
		7	Last one-digit of Assembly Year
		44	Weekly Serial Code

＊）Applicable type numbers listed below

RV1S 9260 ACCSP-10Yx

Marking type number. ”RV1S”and “ACCSP-10Yx””are omitted from original type number

ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number *1
RV1S9260ACCSP -10YC	RV1S9260ACCSP -10YC#SC0	Pb-Free and Halogen Free (Ni/Pd/Au)	Embossed Tape 20 pcs	UL, CSA Approved	RV1S9260A
	RV1S9260ACCSP -10YC#KC0		Embossed Tape 3 500 pcs/reel		
RV1S9260ACCSP -10YV	RV1S9260ACCSP -10YV#SC0		Embossed Tape 20 pcs	UL, CSA, VDE Approved	
	RV1S9260ACCSP -10YV#KC0		Embossed Tape 3 500 pcs/reel		

Notes: *1. For the application of the safety standard, the following part number should be used.

ABSOLUTELY MAXIMUM RATINGS (T_A = 25 °C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Diode	Forward Current	I_F	20	mA
	Reverse Voltage	V_R	5	V
	Power Dissipation *1	P_D	45	mW
Detector	Supply Voltage	V_{DD}	6	V
	Output Voltage	V_O	6	V
	Output Current	I_O	10	mA
	Power Dissipation *2	Pc	250	mW
Isolation Voltage *3		BV	5 000	Vr.m.s.
Operating Ambient Temperature		T_A	–40 to +125	°C
Storage Temperature		T_{stg}	–40 to +150	°C

Notes: *1. Reduced to 1.2 mW/°C at T_A = 110 °C or more.

*2. Reduced to 4.15 mW/°C at T_A = 85 °C or more.

*3. AC voltage for 1 minute at T_A = 25 °C, RH = 60 % between input and output.
Pins 1-2 shorted together, 3-5 shorted together.

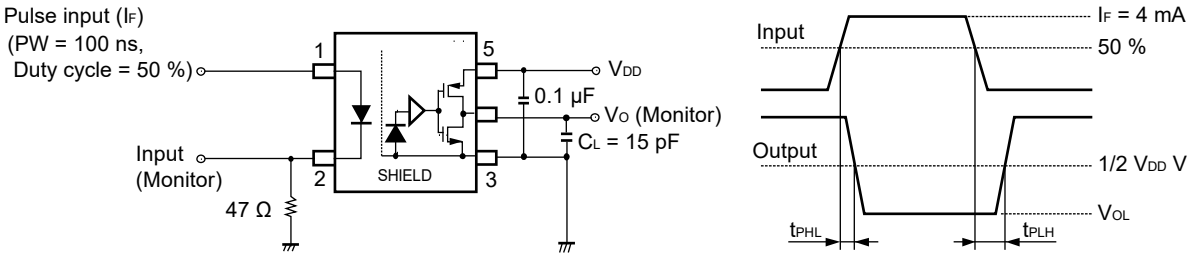
RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	MIN.	TYP.	MAX	Unit
Low Level forward voltage	V_{FL}	0		0.8	V
High Level Forward Current	I_{FH}	3		6	mA
Supply Voltage	V_{DD}	2.7		5.5	V

ELECTRICAL CHARACTERISTICS
(T_A= −40 to +125 °C, V_{DD} = 2.7 to 5.5 V, unless otherwise specified)

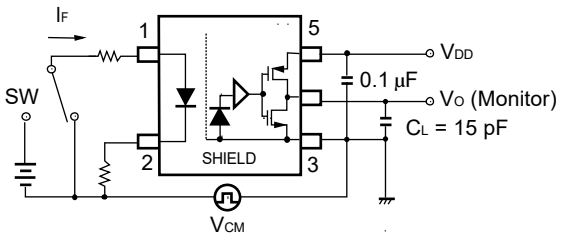
Parameter		Symbol	Conditions	MIN.	TYP.*1	MAX.	Unit
Diode	Forward Voltage	V_F	I_F = 6 mA, T_A = 25 °C	1.4	1.55	1.7	V
	Reverse Current	I_R	V_R = 3 V, T_A = 25 °C			10	μA
	Terminal Capacitance	C_t	V_F = 0 V, f = 1 MHz, T_A = 25 °C		30		pF
Detector	High Level Output Current *2	I_{DDH}	I_F = 0 mA		1.1	2	mA
	Low Level Output Current *2	I_{DDL}	I_F = 3 mA		1.0	2	
	High Level Output Voltage	V_{OH}	I_O = –3.2 mA, I_F = 0 mA	V_{DD} - 1.0	V_{DD}		V
			I_O = –20 μA, I_F = 0 mA	V_{DD} - 0.1	V_{DD}		
	Low Level Output Voltage	V_{OL}	I_O = 3.2 mA, I_F = 3 mA		0.13	0.4	
			I_O = 20 μA, I_F = 3 mA		0.001	0.1	
Coupled	Threshold Input Voltage (H to L) *2	I_{FHL}	V_O < 0.4 V		0.9	2.6	mA
	Propagation Delay Time (H to L) *3	t_{PHL}	I_F = 4 mA ⇔ 0 mA V_{DD} = 3.3 V, 5 V C_L = 15 pF		38	60	ns
	Propagation Delay Time (L to H) *3	t_{PLH}			36	60	
	Pulse Width Distortion *3	PWD = $\lvert t_{PHL} - t_{PLH} \rvert$			2	20	
	Propagation Delay Skew	t_{PSK}				25	
	Rise Time *3	t_r			5		
	Fall Time *3	t_f			5		
	Common Mode Transient Immunity at High Level Output *4	$\lvert CM_H \rvert$	I_F = 0 mA, V_O > 4 V (V_{DD} = 5 V), V_O > 2.3 V (V_{DD} = 3.3 V), V_{CM} = 1.5 kV, T_A = 25 °C	50	60		kV/μs
	Common Mode Transient Immunity at Low Level Output *4	$\lvert CM_L \rvert$	I_F = 3 mA, V_O < 0.4 V (V_{DD} = 3.3 V, 5 V), V_{CM} = 1.5 kV, T_A = 25 °C	50	60		

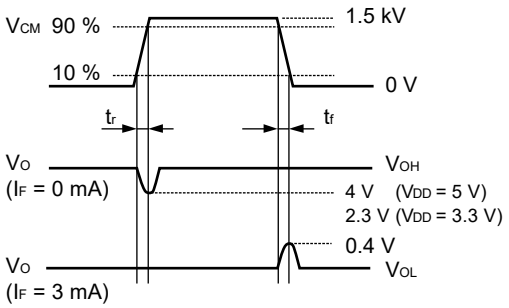
Notes: *1. Typical values at T_A = 25 °C.
*2. The polarity of the current flowing from the external circuit to the RV1S9260A is positive..
*3. Test circuit for propagation delay time



Remark C_L includes probe and stray wiring capacitance.

4. Test circuit for common mode transient immunity measurement

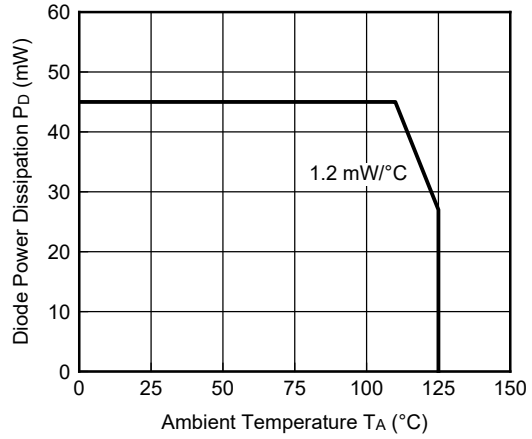




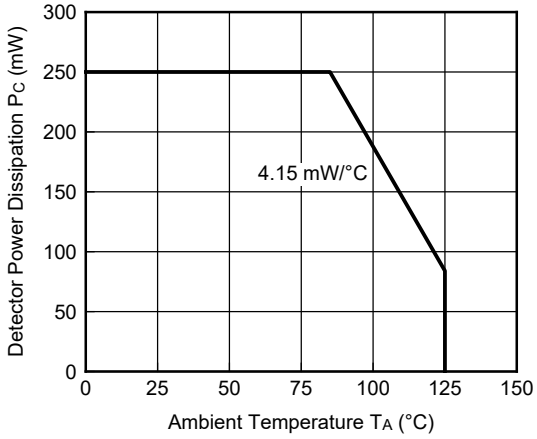
Remark C_L includes probe and stray wiring capacitance.

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

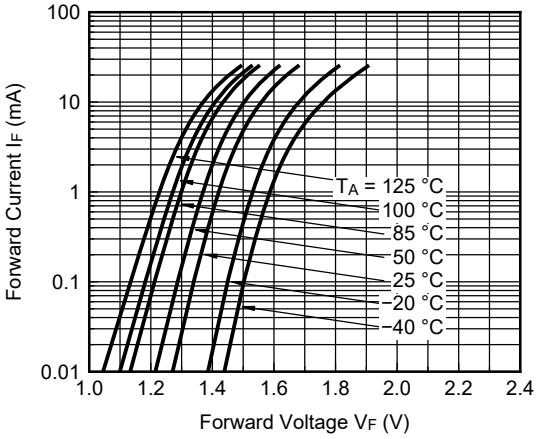
DIODE POWER DISSIPATION vs. AMBIENT TEMPERATURE



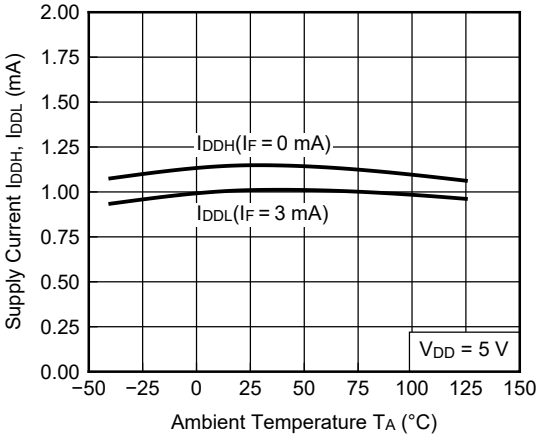
DETECTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



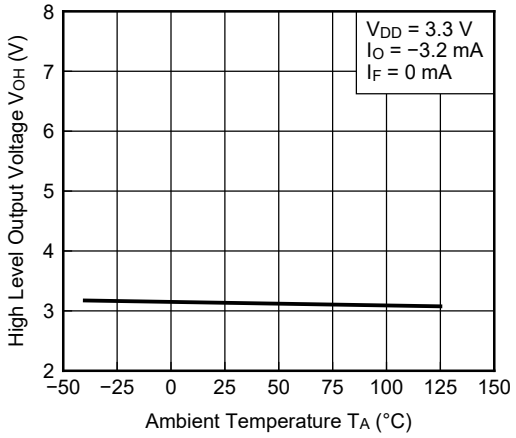
FORWARD CURRENT vs. FORWARD VOLTAGE



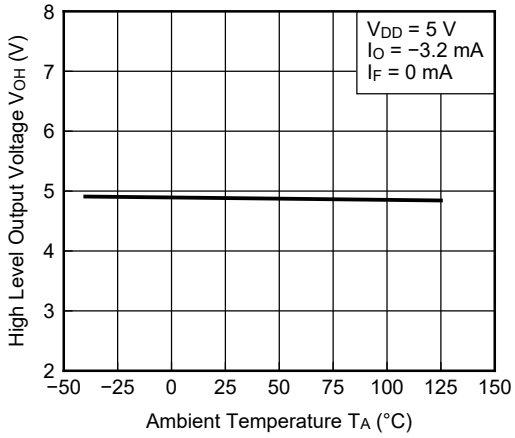
SUPPLY CURRENT vs. AMBIENT TEMPERATURE



HIGH LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



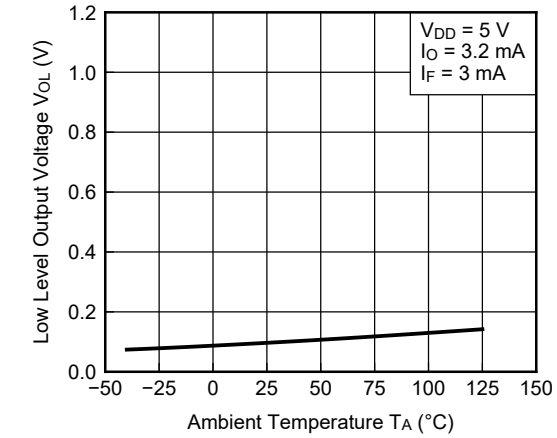
HIGH LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



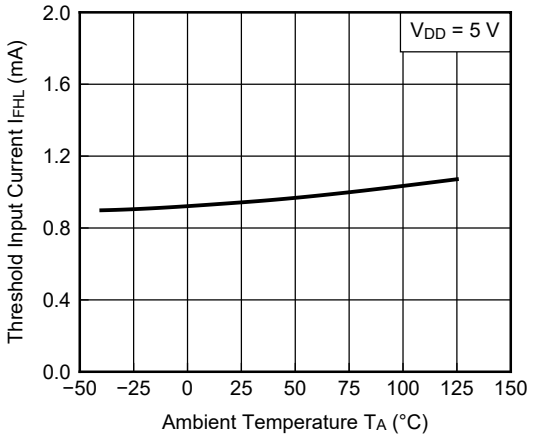
Remark The graphs indicate nominal characteristics.

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise specified)

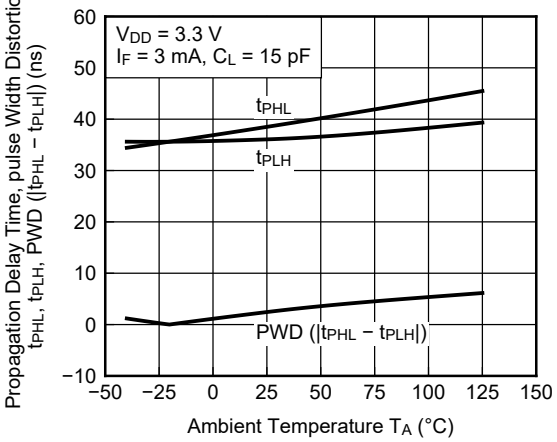
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



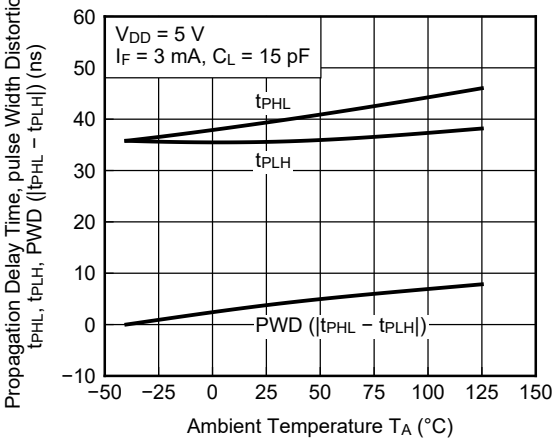
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



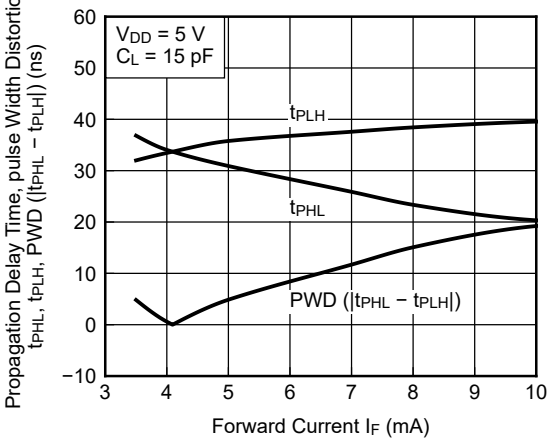
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. AMBIENT TEMPERATURE



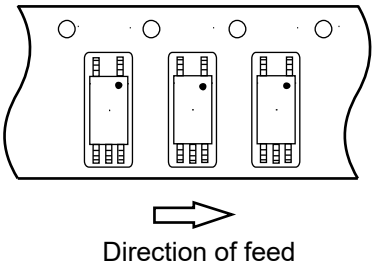
PROPAGATION DELAY TIME, PULSE WIDTH DISTORTION vs. FORWARD CURRENT



Remark The graphs indicate nominal characteristics.

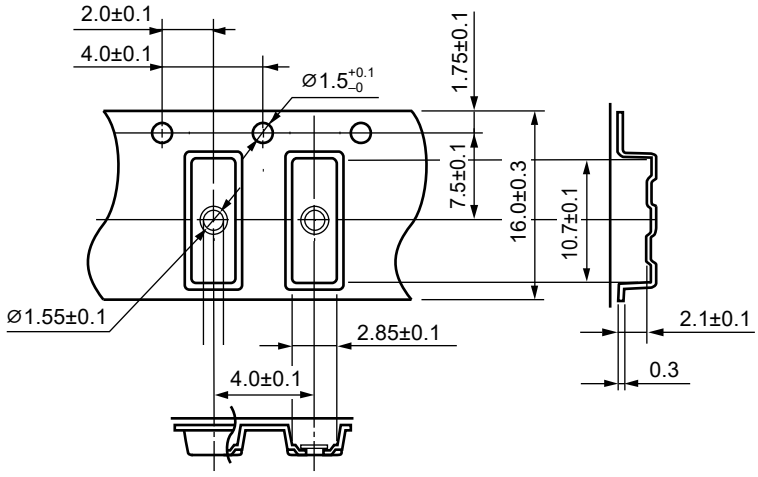
TAPING SPECIFICATIONS (UNIT : mm)

Tape Direction



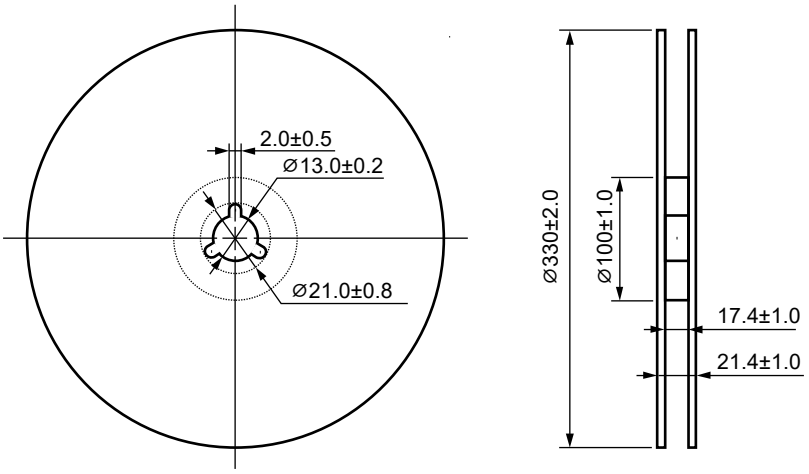
Outline and Dimensions (Tape)

(Unit : mm)



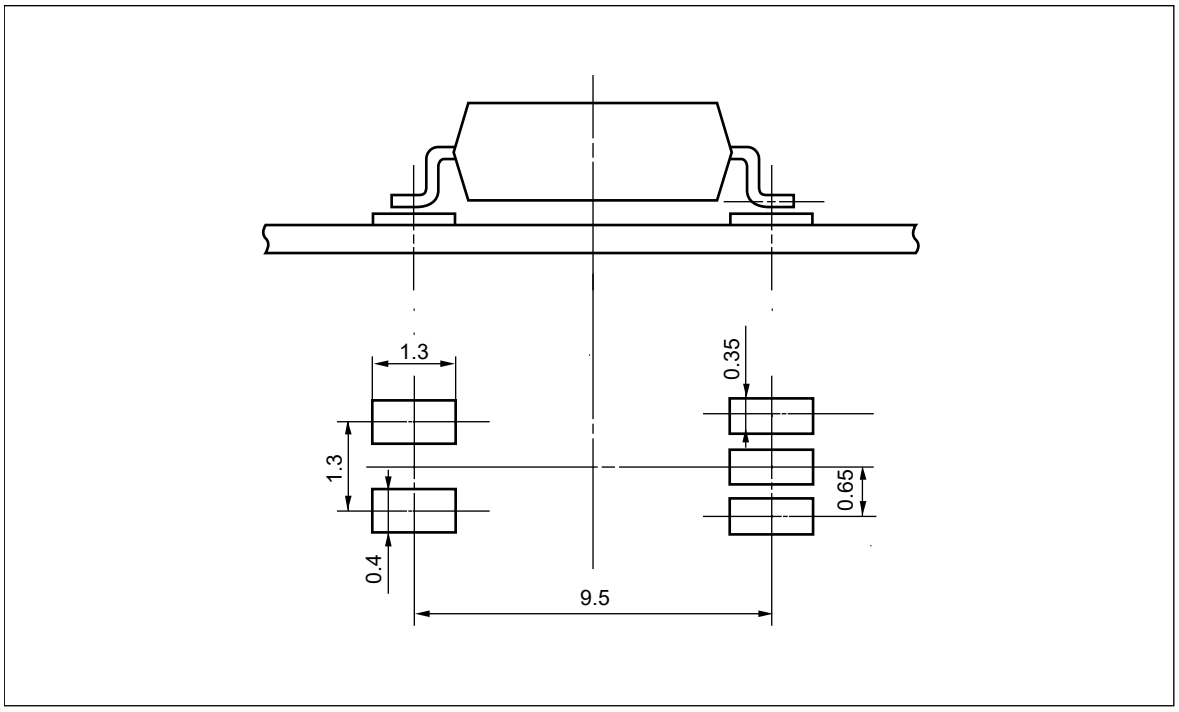
Outline and Dimensions (Reel)

(Unit : mm)



Packing: 3 500 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT : mm)



Remark All dimensions in this figure must be evaluated before use.

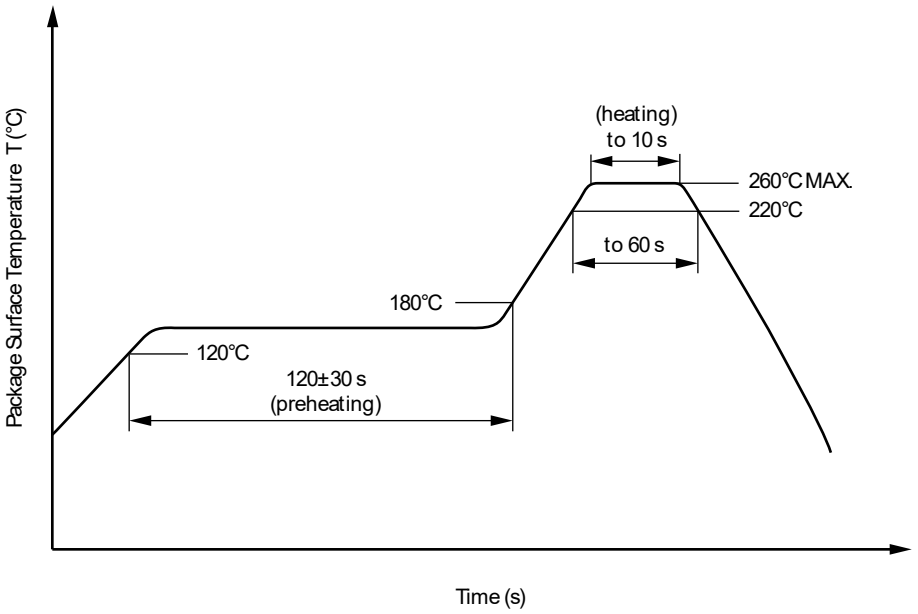
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature — 260 °C or below (package surface temperature)
- Time of peak reflow temperature — 10 s or less
- Time of temperature higher than 220 °C — 60 s or less
- Time to preheat temperature from 120 to 180 °C — 120 ± 30 s
- Number of reflows — Three
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature — 260 °C or below (molten solder temperature)
- Time — 10 s or less
- Preheating conditions — 120 °C or below (package surface temperature)
- Number of times — One (Allowed to be dipped in solder including plastic mold portion.)
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak temperature (lead part temperature) — 350 °C or below
- Time (per one side) — 3 s or less
- Flux — Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)
- Place — 1.5 to 2.0 mm or more away from the root of the lead

(4) Cautions

- Flux cleaning — Avoid cleaning with Freon- or halogen-based (chlorinated etc.) solvents.
- Fixing/Coating — Do not use fixing agents or coatings containing halogen-based substances.

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

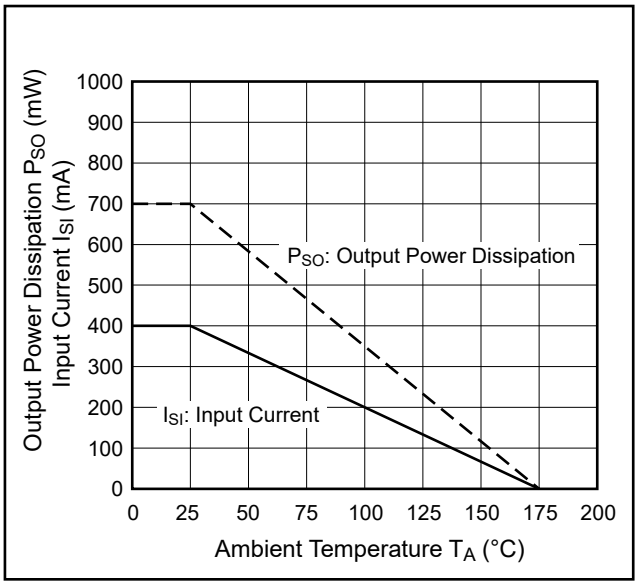
USAGE CAUTIONS

1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of more than 0.1 μF is used between V_{DD} and GND near device. Also, ensure that the distance between the leads of the photocoupler and capacitor is no more than 10 mm.
3. Avoid storage at a high temperature and high humidity.

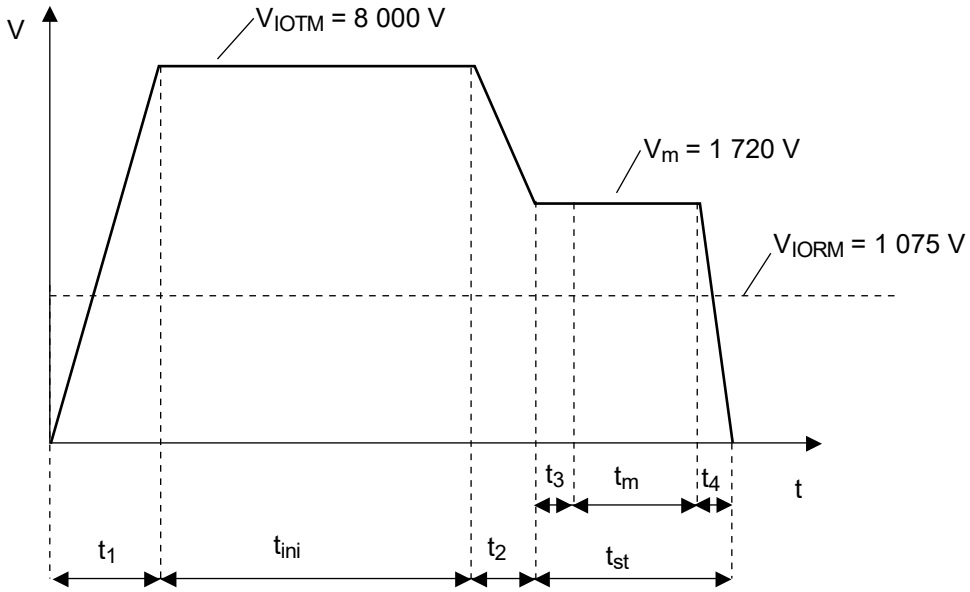
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Rating	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		40/125/21	
Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $V_m = 1.6 \times V_{IORM.}$, $q_{pd} < 5$ pC	 V_{IORM} V_m	 1 075 1 720	 V_{peak} V_{peak}
Test voltage (partial discharge test, procedure b for all devices) $V_m = 1.875 \times V_{IORM.}$, $q_{pd} < 5$ pC	V_m	2 016	V_{peak}
Highest permissible overvoltage	V_{IOTM}	8 000	V_{peak}
Degree of pollution (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303-11))	CTI	400	
Material group (IEC 60664-1/DIN EN 60664-1 (VDE 0110-1))		II	
Storage temperature range	T_{stg}	−40 to +150	°C
Operating temperature range	T_A	−40 to +125	°C
Isolation resistance, minimum value V_{I-O} = 500 V dc, T_A = 25 °C V_{I-O} = 500 V dc, T_A = maximum temperature of rating, at least 100 °C	 R_{I-O} MIN. R_{I-O} MIN.	 10^{12} 10^{11}	 Ω Ω
Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Maximum ambient temperature Maximum input current Maximum output power dissipation Isolation resistance, minimum value at V_{I-O} = 500 V dc, $T_A = T_S$	 T_S I_{SI} P_{SO} R_{I-O} MIN.	 175 400 700 10^9	 °C mA mW Ω

Dependence of maximum safety ratings on ambient temperature

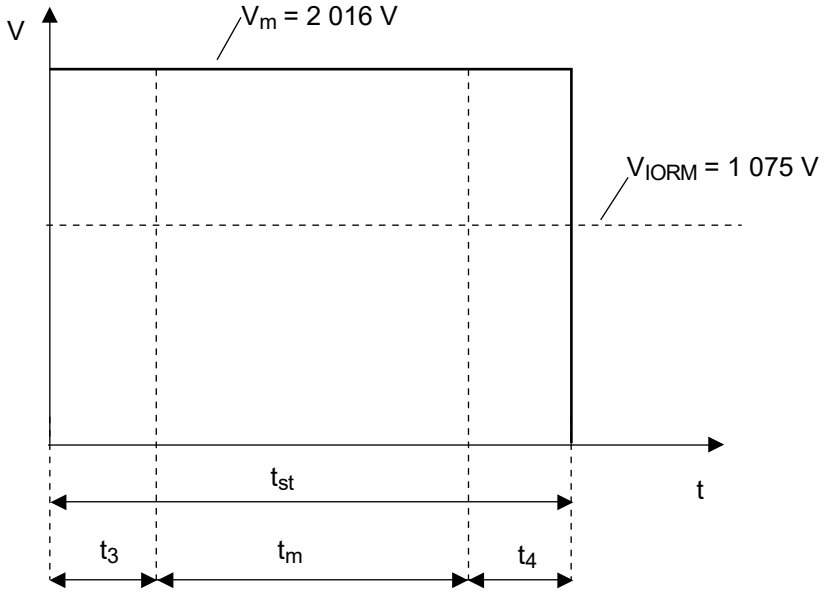


Method a) Destructive Test, Type and Sample Test



t_1, t_2 = 1 to 10 sec
t_3, t_4 = 1 sec
t_m = 10 sec
t_{st} = 12 sec
t_{ini} = 60 sec

Method b) Non-destructive Test, 100% Production Test



t_3, t_4 = 0.1 sec
t_m = 1.0 sec
t_{st} = 1.2 sec

Caution GaAs Products	This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points. • Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below. 1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials. 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal. • Do not burn, destroy, cut, crush, or chemically dissolve the product. • Do not lick the product or in any way allow it to enter the mouth.

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